



Data Sheet

Customer:

Part No:

Sample No:

Description:

Item No:

CL-3014UVC1C-400-05

3Ø Lamp 400nm UVA

Customer			
Check	Inspection	Approval	Date



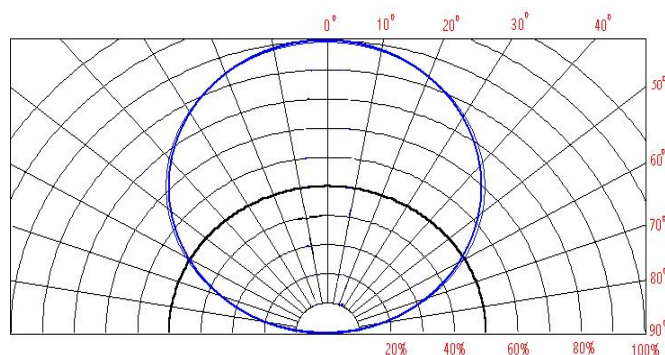
Features

- Long service life
- High brightness
- Energy saving and environmental protection
- Low DC voltage operation
- Quick response
- Photometric tunable
- Short wavelength, strong penetration
- Strong antistatic ability
- Eutectic process
- RoHS compliant

Applications

- All kinds of sterilization
- UV light therapy, beauty and manicure
- Anti-counterfeit detection
- Photocatalytic air purification
- UV curing
- Plant lighting
- Printing equipment

Radiation Pattern



Typical Optical/ Electrical Characteristics @TJ=25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=20mA	3.2	---	3.8	V
Reverse Current	IR	VR=5v	--	--	10	μA
50% Power Angle	2θ1/2	IF=20mA	---	60	---	deg
Luminous Intensity	φ V	IF=20mA	20	--	50	mw
Recommend Forward Current	IF	--	--	20	--	mA
Chromaticity	λ P	IF=20mA	400	405	410	nm
Junction temperature	TJ	IF=20mA	--	125	--	°C
Thermal Resistance,Junction to Case	RJP	IF=20mA	--	8	--	°C/W

Notes: 1. Tolerance of measurement of forward voltage ±0.1V.
2. Tolerance of measurement of peak Wavelength ±2.0nm.
3. Tolerance of measurement of luminous intensity ±5%.

Absolute Maximum Rating

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	30	mA
Pulse Forward Current*	IFP	100	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	100	mW
Operation Temperature	TOPR	-40~+80	°C
Storage Temperature	TSTG	-40~+100	°C
Lead Soldering Temperature*	TSOL	Max. 260°C for 5sec Max.	

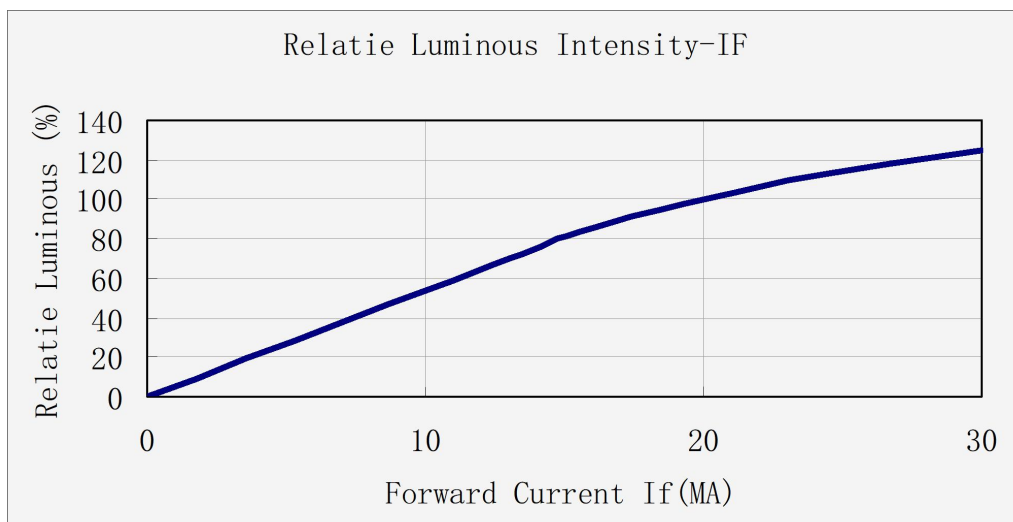
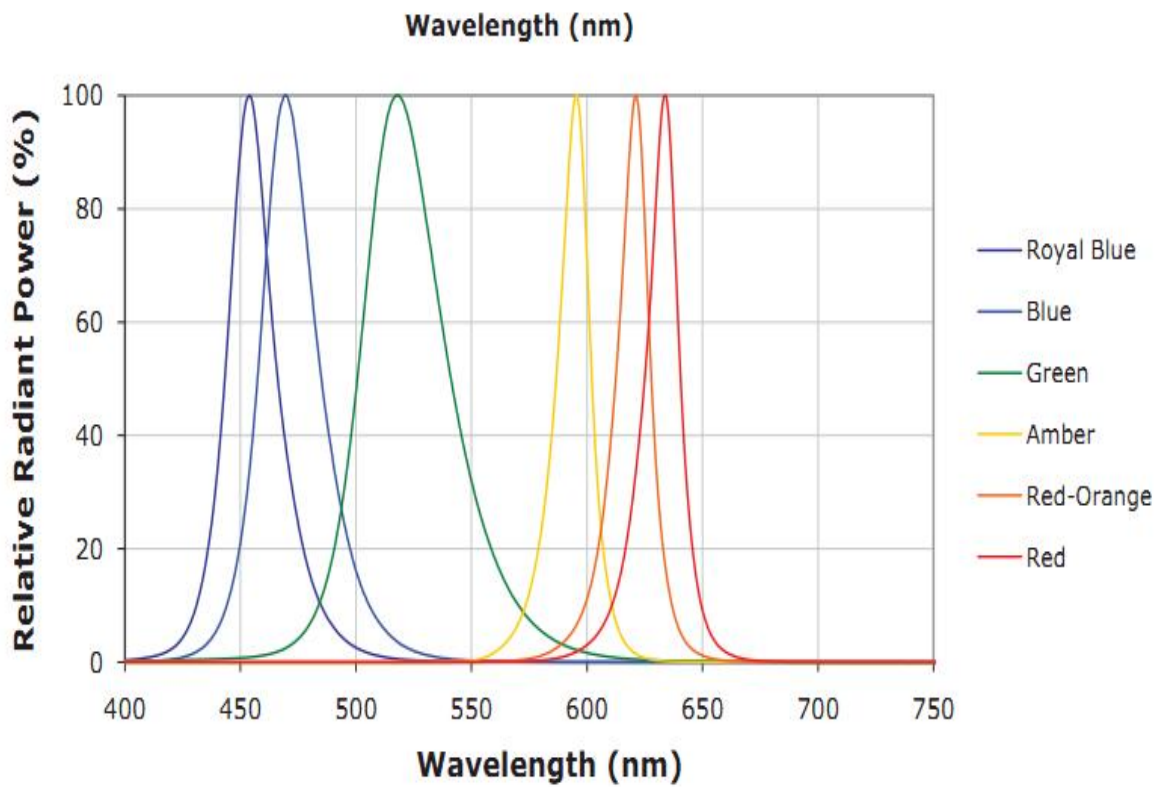
*IFP Conditions: Pulse Width ≤ 10msec duty ≤ 1/10

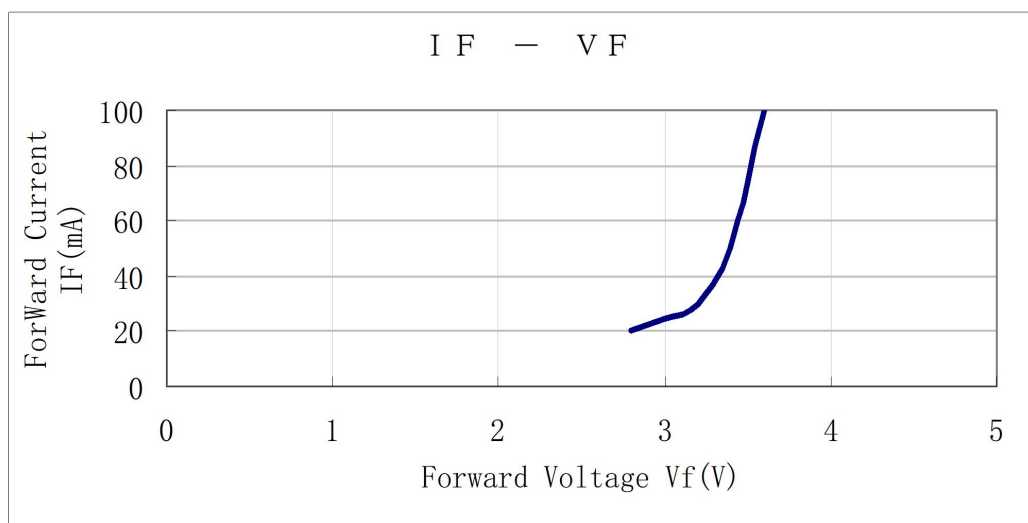
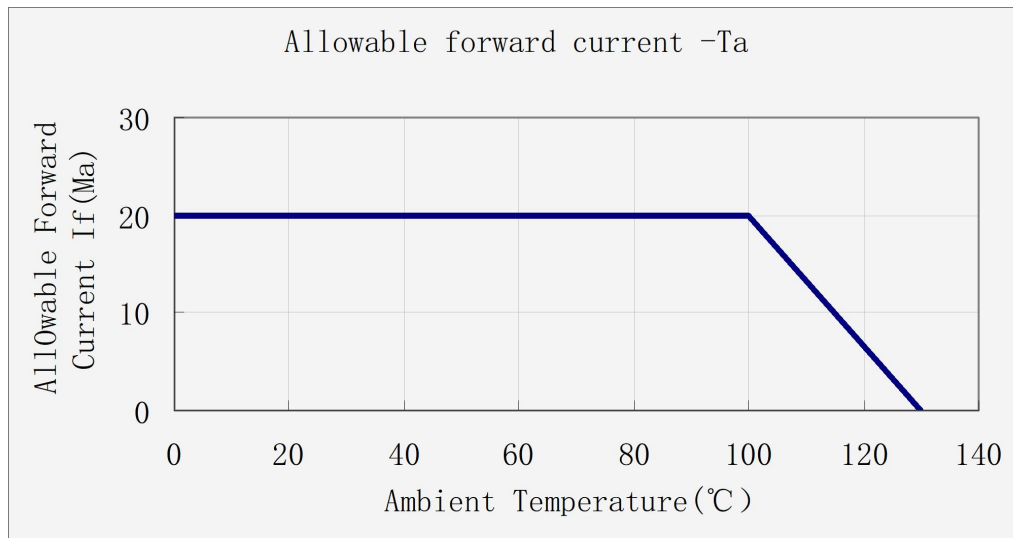
* All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.

*Re-flow, wave peak and soak-stannum soldering etc. is not suitable for High power integrated light source.

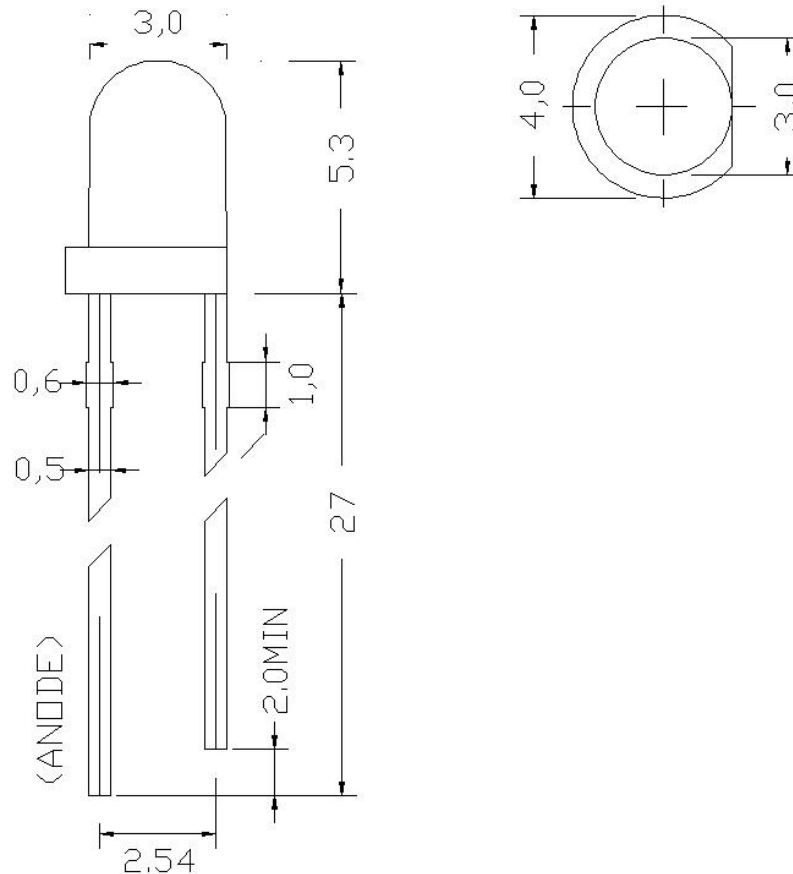
*Suggest to solder it by professional high power LED soldering machine.

*Can use invariable-temperature searing-iron with soldering condition : ≤ 260 degree less than 3 seconds.





Package Dimensions (MM)

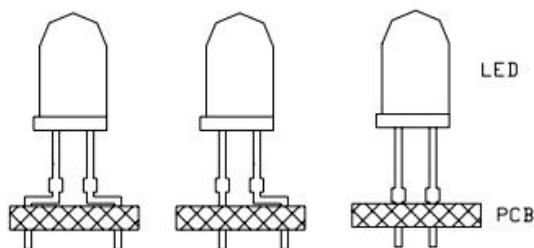


- Notes:
1. All dimension units are millimeters.
 2. All dimension tolerance is $\pm 0.2\text{mm}$ unless otherwise noted.
 3. The brass column of heat sink of the high power LED is Anode. Please pay more attention to the necessary installation, when installing The heat dissipate on equipments and connecting the electric circuit in avoid of short circuit and destroying

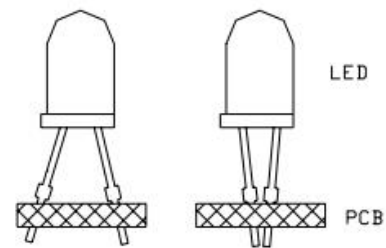
Package Adhesive Pipe (units:mm)

Note:

- 1 LED bracket forming method: The pin of LED can be bent where is at least 2mm out of LED colloid; Finishing the forming of LED bracket must be before soldering; Guarantee the gap between two pin of LED tallys with LED pads in PCB when forming;
- 2 Manual soldering: The tip temperature of soldering iron don't exceed 300℃; soldering time don't exceed 3s and soldering position must be 3mm out of led colloid;
- 3 Static electricity and high volt can damage LED, The production whose Die material is InGaN must strictly required ESD, Must put on static glove and static fillet, soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.
- 4 Protecting countermeasure when over current: Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation
- 5 LED installation method: LED can be stored for a year under the condition, the temperture of 5℃~35℃ and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.
- 6 If LED is exposed in air for a week under the condition, the temperature of 5℃~35℃, humidity of RH60%, must place the LED in the ambience of 65℃ ±5℃ for 24 hours .



正确方式



错误方式